6A05G – 6A100G

Taiwan Semiconductor

VALUE

6

UNIT

A

6A, 50V - 1000V Standard Rectifier

FEATURES

- AEC-Q101 qualified available
- Glass passivated chip junction
- High current capability, Low $V_{\rm F}$
- High reliability
- High surge current capability
- Low power loss
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- General purpose

MECHANICAL DATA

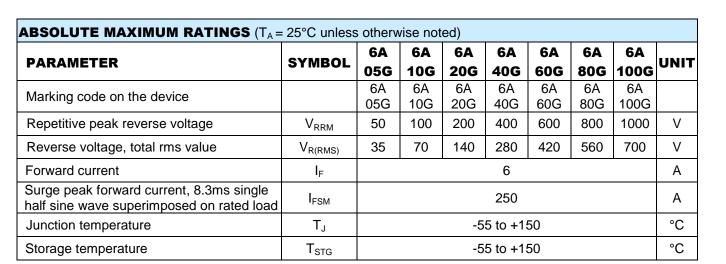
- Case: R-6
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Pure tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 1.65g (approximately)

V _{RRM}	50 - 1000	V	
I _{FSM}	250	А	
T _{J MAX}	150	°C	
Package	R-6		
Configuration	Single die		
	HS HALOC	GEN E	

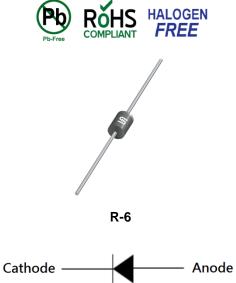
KEY PARAMETERS

PARAMETER

 I_{F}



1







THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	35	°C/W

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	6A05G 6A10G	I _F = 6A, T _J = 25°C	V _F	-	1.1	V
	6A20G 6A40G 6A60G 6A80G 6A100G			-	1.0	V
Reverse current @ rated $V_R^{(2)}$		$T_J = 25^{\circ}C$	- I _R	-	10	μA
		T _J = 125°C		-	100	μA
Junction capacitance		1MHz, $V_{R} = 4.0V$	CJ	60	-	pF

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

DERING INFORMATION		
ORDERING CODE ⁽¹⁾⁽²⁾	PACKAGE	PACKING
6AxG	R-6	1,000 / Tape & Reel
6AxG A0G	R-6	700 / Ammo box
6AxGH	R-6	1,000 / Tape & Reel
6AxGHA0G	R-6	700 / Ammo box

Notes:

1. "x" defines voltage from 50V (6A05G) to 1000V (6A100G)

2. "H" means AEC-Q101 qualified



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

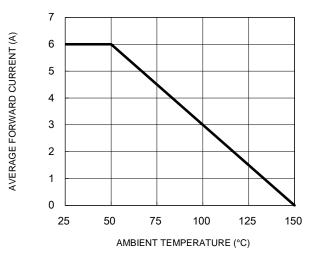
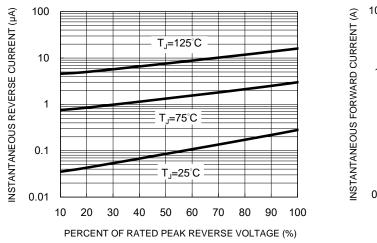


Fig.3 Typical Reverse Characteristics



100 (10) 100 100 (10)

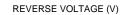


Fig.4 Typical Forward Characteristics

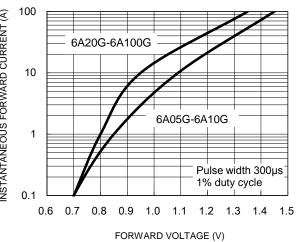


Fig.5 Maximum Non-Repetitive Forward Surge Current

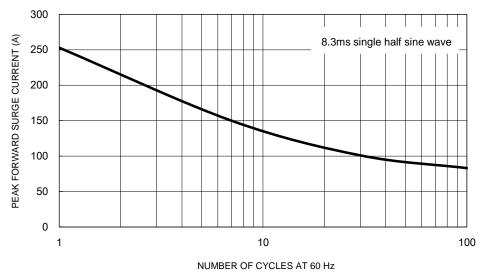
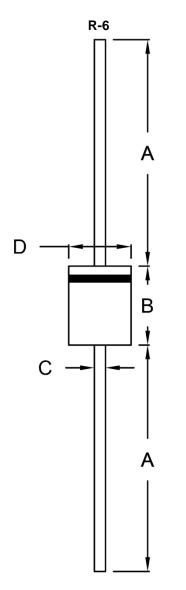


Fig.2 Typical Junction Capacitance

PACKAGE OUTLINE DIMENSIONS



DIM.	Unit	(mm)	Unit ((inch)
	Min.	Max.	Min.	Max.
А	25.40	-	1.000	-
В	8.60	9.10	0.339	0.358
С	1.20	1.30	0.047	0.051
D	6.80	7.20	0.268	0.283

MARKING DIAGRAM



P/N	= Marking Code
G	= Green Compound
YWW	= Date Code
F	= Factory Code



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